



High-end Power Semiconductor Manufacturer

KP5000A 4500V-5600V

Phase Control Thyristor

- High power cycling capability
- Low on-state and switching losses
- Designed for traction and industrial applications



| | | | | | | | |
|-----------------------------------|-----------|------|------|-----------|---------------|------|------|
| Mean on-state current | | | | I_{TAV} | 5000 A | | |
| Repetitive peak off-state voltage | | | | V_{DRM} | 4500 – 5600 V | | |
| Repetitive peak reverse voltage | | | | V_{RRM} | | | |
| Turn-off time | | | | t_q | 1000 μ s | | |
| V_{DRM}, V_{RRM}, V | 4500 | 4600 | 4800 | 5000 | 5200 | 5400 | 5600 |
| Voltage code | 45 | 46 | 48 | 50 | 52 | 54 | 56 |
| $T_j, ^\circ\text{C}$ | -40 – 115 | | | | | | |

MAXIMUM ALLOWABLE RATINGS

| Symbols and parameters | | Units | Values | Test conditions | |
|------------------------|---|--------------------------------|-----------|--|--|
| ON-STATE | | | | | |
| I_{TAV} | Mean on-state current | A | 5000 | $T_c=70\text{ }^{\circ}\text{C}$; 180° half-sine wave; | |
| I_{TRMS} | RMS on-state current | A | 7850 | $T_c=70\text{ }^{\circ}\text{C}$ | |
| I_{TSM} | Surge on-state current | kA | 95.0 | $T_j=T_{j\max}$ | 180° half-sine wave; ($t_p=10\text{ ms}$); $V_R=0\text{ V}$; |
| I^2t | Safety factor | $\text{A}^2\text{s}\cdot 10^4$ | 4510 | | 180° sine wave; ($t_p=10\text{ ms}$); |
| BLOCKING | | | | | |
| V_{DRM}, V_{RRM} | Repetitive peak off-state and Repetitive peak reverse voltages | V | 4500-5600 | $T_{j\min} < T_j < T_{j\max}$; 180° half-sine wave; 50 Hz; Gate open | |
| V_{DSM}, V_{RSM} | Non-repetitive peak off-state and Non-repetitive peak reverse voltages | V | 5400-6500 | $T_{vj} = 25, 115\text{ }^{\circ}\text{C}$; $I_{DRM}, I_{RRM}\leq 800\text{ mA}$; $V_{DM} = V_{DRM}$; $V_{RM} = V_{RRM}$; $t_0= 10\text{ ms}$; Gate open | |

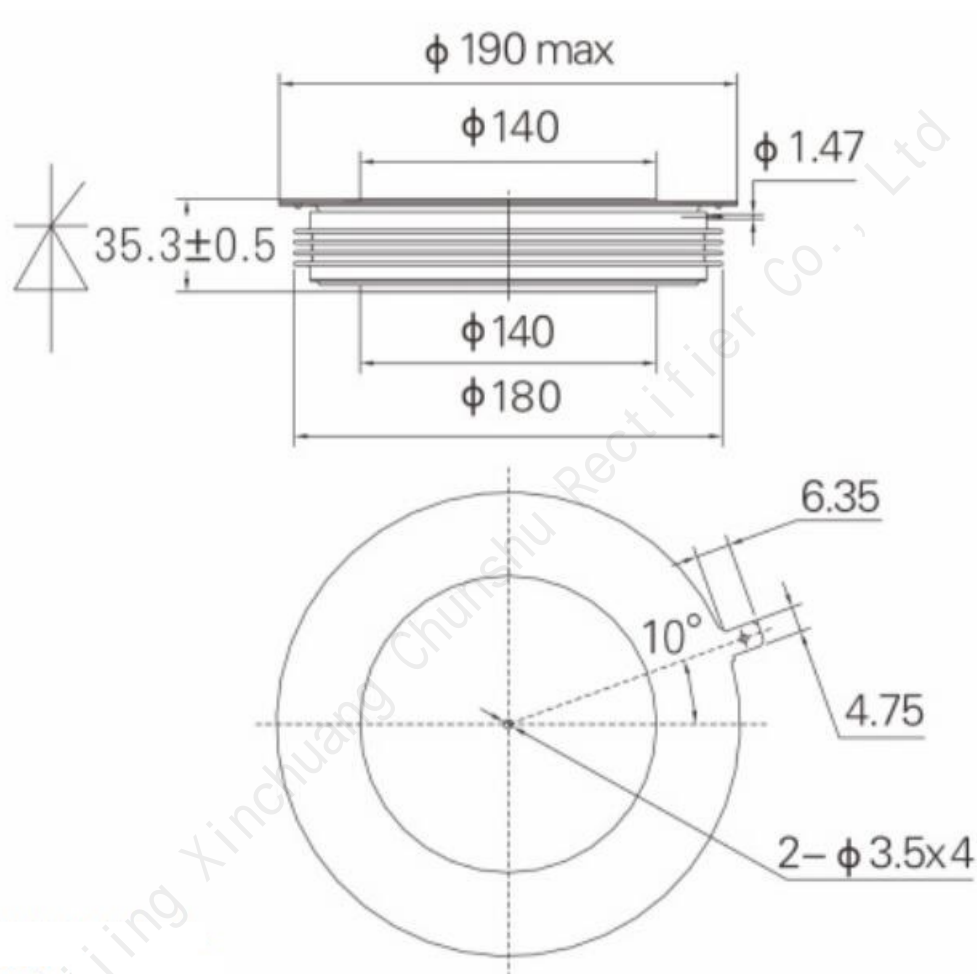
| TRIGGERING | | | | |
|--------------------|--|--------------------|---------|--|
| I_{FGM} | Peak forward gate current | A | 4 | |
| V_{RGM} | Peak reverse gate voltage | V | 5 | |
| P_G | Gate power dissipation | W | 20 | |
| SWITCHING | | | | |
| $(di_T/dt)_{crit}$ | Critical rate of rise of on-state current non-repetitive | A/ μ s | 200 | $T_{vj} = 115\text{ }^{\circ}\text{C}; V_{DM} = 0.67 V_{DRM};$ $f = 50\text{ Hz}; I_{TM} = 5000\text{ A};$ $I_{FG} = 2\text{ A}; t_r = 0.5\text{ }\mu\text{s}$ |
| THERMAL | | | | |
| T_{stg} | Storage temperature | $^{\circ}\text{C}$ | -40-140 | |
| T_j | Operating junction temperature | $^{\circ}\text{C}$ | -40-115 | |
| MECHANICAL | | | | |
| F | Mounting force | kN | 180.0 | |

CHARACTERISTICS

| Symbols and parameters | | Units | Values | Conditions |
|------------------------|---|------------|--------|--|
| ON-STATE | | | | |
| V_{TM} | Peak on-state voltage, max | V | 2.01 | $T_j = 115\text{ }^{\circ}\text{C}; I_{TM} = 6000\text{ A}$ |
| $V_{T(TO)}$ | On-state threshold voltage, max | V | 1.05 | $T_j = T_{j\text{ max}}$ |
| r_T | On-state slope resistance, max | m Ω | 0.160 | |
| I_L | Latching current, max | mA | 1000 | $T_j = 25\text{ }^{\circ}\text{C}$ |
| I_H | Holding current, max | mA | 200 | $T_j = 25\text{ }^{\circ}\text{C}$ |
| BLOCKING | | | | |
| I_{DRM}, I_{RRM} | Repetitive peak off-state and Repetitive peak reverse currents, max | mA | 800 | $T_j = 25\text{ }^{\circ}\text{C}, 115\text{ }^{\circ}\text{C};$ $V_{DRM}/V_{RRM};$ Gate open |
| $(dv_D/dt)_{crit}$ | Critical rate of rise of off-state voltage ¹⁾ , min | V/ μ s | 2000 | $T_j = T_{j\text{ max}};$ $V_D = 0.67 \cdot V_{DRM};$ Gate open |
| TRIGGERING | | | | |
| V_{GT} | Gate trigger direct voltage, max | V | 3.00 | $T_j = 25\text{ }^{\circ}\text{C}$ |
| I_{GT} | Gate trigger direct current, max | mA | 300 | $T_j = 25\text{ }^{\circ}\text{C}$ |
| V_{GD} | Gate non-trigger direct voltage, min | V | 0.30 | $T_j = T_{j\text{ max}};$ $V_D = 0.4 \cdot V_{DRM};$ |
| SWITCHING | | | | |
| t_q | Turn-off time ²⁾ , max | μ s | 1000 | $T_{vj} = 115\text{ }^{\circ}\text{C}; V_{DM} = 0.67 V_{DRM};$ $I_T = 2000\text{ A}; dv/dt = 20\text{ V}/\mu\text{s};$ $V_R = 200\text{ V}; -di/dt = 1.5\text{ A}/\mu\text{s}$ |
| Q_{rr} | Total recovered charge, max | μ C | 6000 | $T_{vj} = 125\text{ }^{\circ}\text{C}; -di/dt = 1.5\text{ A}/\mu\text{s};$ $I_T = 2000\text{ A}; V_R = 200\text{ V}$ |
| I_{rrM} | Peak reverse recovery current, max | mA | 800 | $T_{vj} = 25\text{ }^{\circ}\text{C}, 115\text{ }^{\circ}\text{C}; V_{DRM}/V_{RRM}$ Gate open |

THERMAL

| | | | | |
|-------------------|---|----------------------|--------|----------------|
| R_{thjc} | Thermal resistance, junction to case, max | $^{\circ}\text{C/W}$ | 0.0028 | Direct current |
| R_{thck} | Thermal resistance, case to heatsink, max | $^{\circ}\text{C/W}$ | 0.0005 | Direct current |
| MECHANICAL | | | | |
| w | Weight, typ | g | 4500 | |

OVERALL DIMENSIONS

KT150DT

All dimensions in millimeters

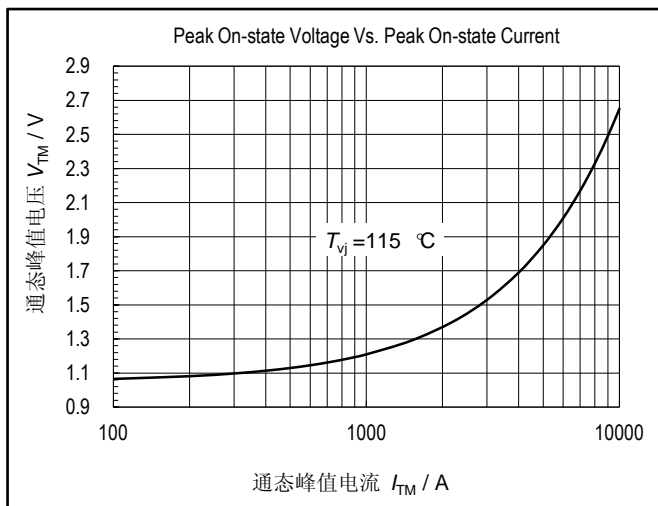


图1. 通态伏安特性曲线

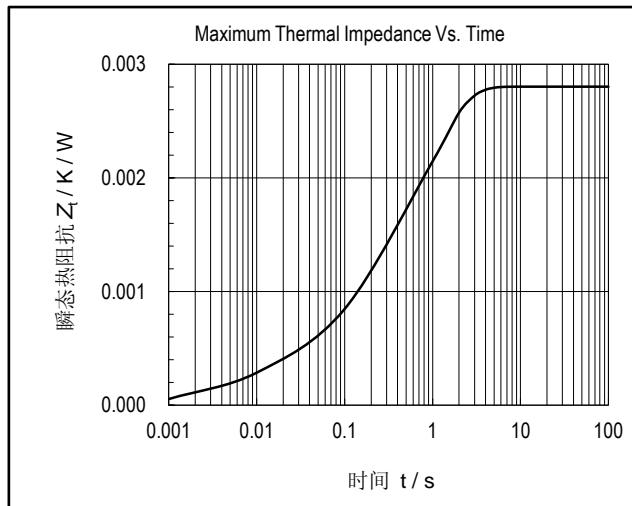


图2. 瞬态热阻抗曲线

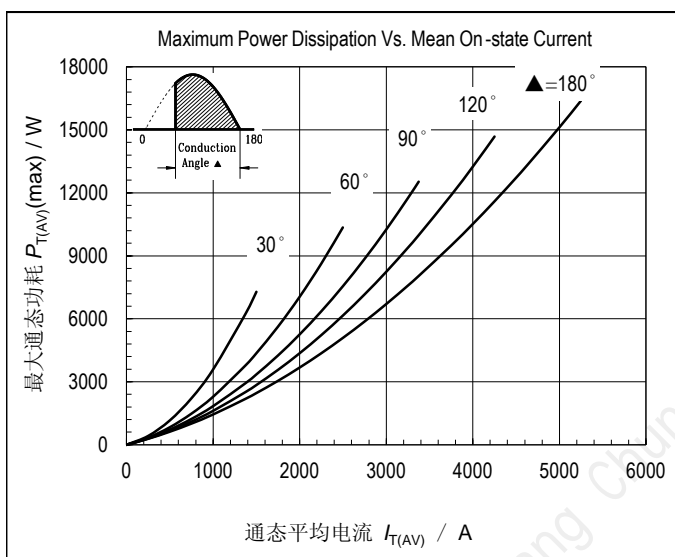


图3. 最大功耗与通态平均电流的关系曲线

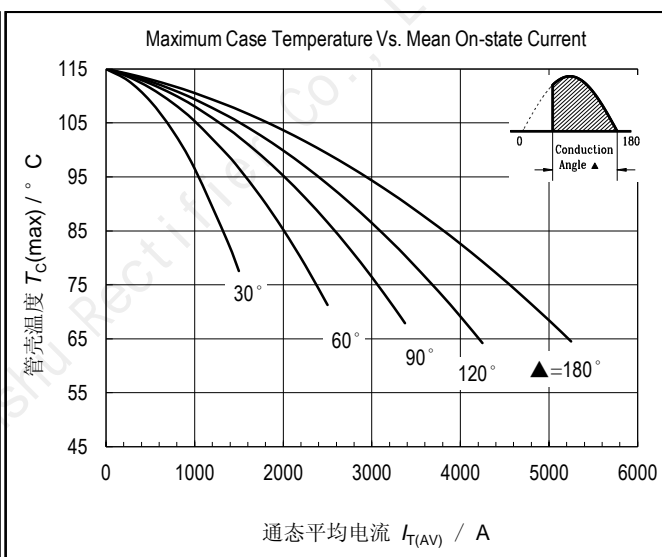


图4. 管壳温度与通态平均电流的关系曲线

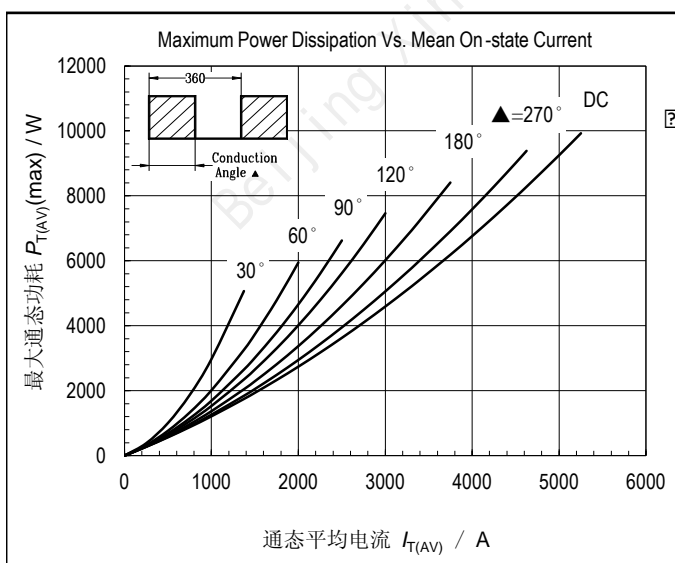


图5. 最大通态功耗与通态平均电流的关系曲线

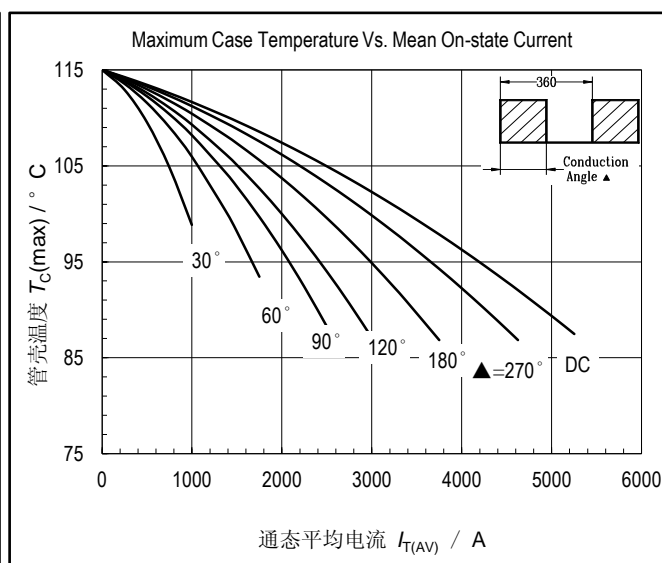


图6. 管壳温度与通态平均电流的关系曲线

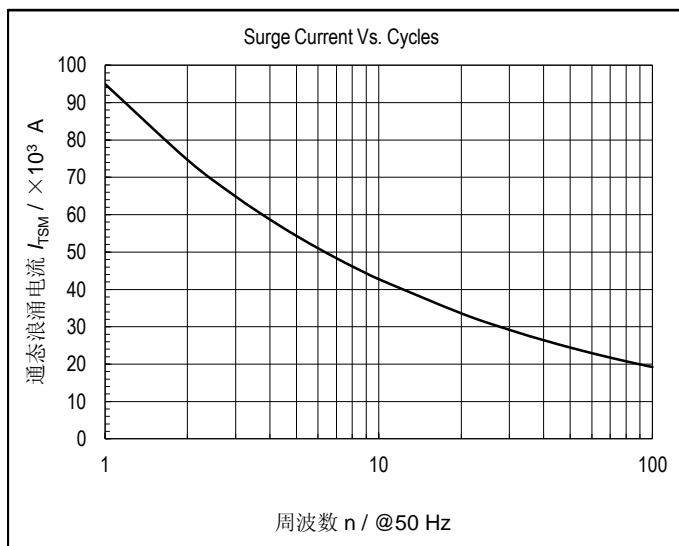


图7. 通态浪涌电流与周波数的关系曲线

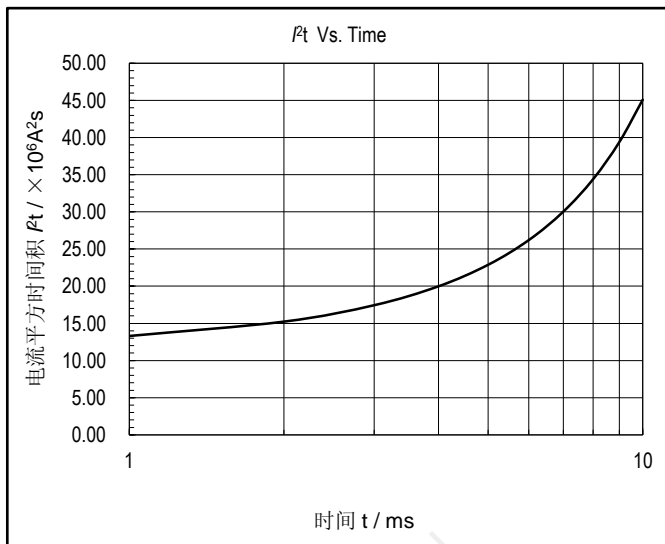


图8. I^2t 特性曲线

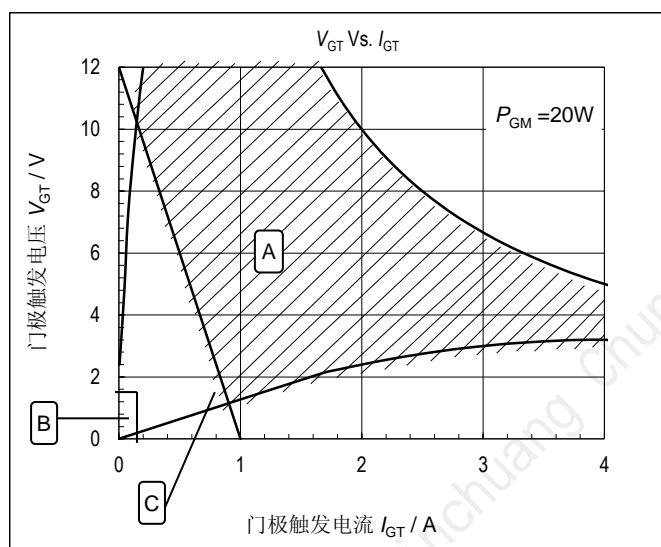


图9. 门极触发特性曲线

A为可靠触发区，
B为不可靠触发区。
C为建议采用的门极负载线。

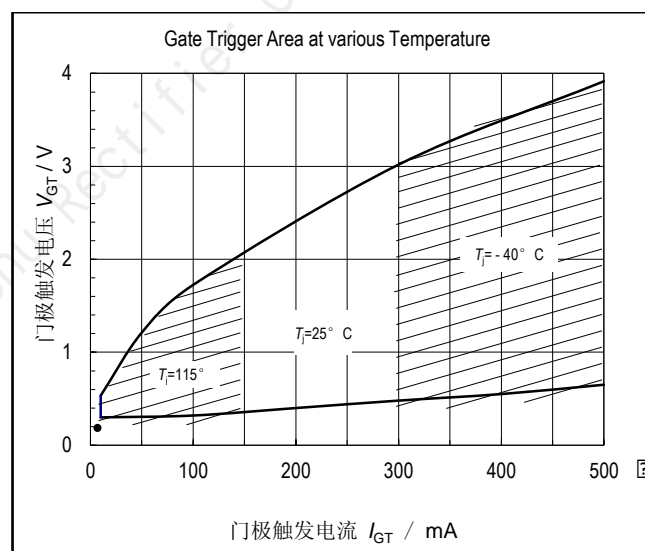


图10. 不同结温下的门极触发区

A is Recommended Triggering Area.
B is Unreliable Triggering Area.
C is Recommended Gate Load Line.